

DEC 24 2008

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December 24, 2008

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To: Examiner Khiem D. Nguyen Facsimile No: (571) 273-1865
Company: U.S. Patent and Trademark Office Attorney Docket No. 038915.00045
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Re: Method for Analyzing Copper Electroplating Solution, Apparatus for the Analysis, and Method
for Fabricating Semiconductor Product

Message:

Dear Examiner Nguyen:

Per our conversation this morning we submit a copy of the Response originally e-filed on September 17, 2008, for
application number 10/550,153. DEC 24 PM 12:27

Please do not hesitate to contact us, if you need additional information.

Thank you.

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Examiner: Khiem D. Nguyen
Toshikazu Okubo et al.

Serial No. 10/550,153 Art Unit: 2823

Filed: September 20, 2005 Confirmation No.: 1053

Title: Method for Analyzing Copper Electroplating Solution, Apparatus for the Analysis, and Method for Fabricating Semiconductor Product

RESPONSE TO OFFICE ACTION

Dear Examiner Nguyen:

This is a response to the Office Action dated July 3, 2008, which has a shortened statutory period for reply that ends on October 3, 2008. Please amend the above-identified application as follows.

Amendments to the Claims begins on page 2 of this paper.

Remarks begin on page 10 of this paper.